



## 40W,28V Plastic RF LDMOS Transistor

**ITEH22041C6**

### Description

The ITEH22041C6 is a dual path 40-watt, highly rugged, LDMOS transistor, designed for driver applications at frequencies from 1.8 to 2.2GHz, in 10\*6mm QFN plastic package, supporting surface mounted on PCB through high density grounding vias.

**It can be configured as highly compact Doherty ,ideal for high efficiency and low cost, DPD friendly driver for 4G/5G application within 1.8-2.2GHz.**



- Typical 1.8GHz Doherty RF Performance (On Innogrator fixture with device soldered).

V<sub>ds</sub>=28V I<sub>dq\_main</sub>=180mA, V<sub>gs\_peak</sub>=2.15V

Freq (MHz)	Pulse CW Signal			P <sub>avg</sub> =34dBm WCDMA Signal		
	P1dB Gain (dB)	P3dB (W)	Eff@P3dB (%)	Gp (dB)	Eff(%)	ACPR <sub>5M</sub> (dBc)
1805	14.05	40.26	57.96	15.5	26.2	-36.5
1842	14.49	42.73	58.46	15.6	27.0	-37.1
1880	13.92	44.14	58.56	15.3	27.2	-38.2

- Typical 2.1GHz Doherty RF Performance (On Innogrator fixture with device soldered).

V<sub>ds</sub>=28V I<sub>dq\_main</sub>=150mA, V<sub>gs\_peak</sub>=2.15V

Freq (MHz)	Pulse CW Signal			P <sub>avg</sub> =34dBm WCDMA Signal		
	P1dB Gain (dB)	P3dB (W)	Eff@P3dB (%)	Gp (dB)	Eff(%)	ACPR <sub>5M</sub> (dBc)
2110	16.20	50.30	59.82	17.27	26.7	-41.10
2140	16.63	46.88	60.94	17.40	27.1	-42.48
2170	16.93	42.23	60.37	17.35	27.1	-41.86

### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### Suitable Applications

- L, S band power amplifier
- All 4G/5G cellular application within 1.8 to 2.2GHz

**Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
Drain--Source Voltage	V <sub>DSS</sub>	+65	Vdc
Gate--Source Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+28	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T <sub>j</sub>	+225	°C

**Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case $T_C = 85^\circ\text{C}$ , $T_J = 200^\circ\text{C}$ , DC test	$R_{\theta JC}$	0.5	$^\circ\text{C/W}$

**Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

**Table 4. Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

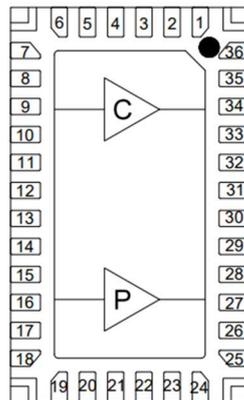
Characteristic	Symbol	Min	Typ	Max	Unit
<b>DC Characteristics</b> Drain-Source Voltage $V_{GS} = 0$ , $I_{DS} = 100\mu\text{A}$	$V_{(BR)DSS}$		65		V
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 28\text{V}$ , $V_{GS} = 0\text{V}$ )	$I_{DSS}$	—	—	1	$\mu\text{A}$
Gate--Source Leakage Current ( $V_{GS} = 11\text{V}$ , $V_{DS} = 0\text{V}$ )	$I_{GSS}$	—	—	1	$\mu\text{A}$
Gate Threshold Voltage ( $V_{DS} = 28\text{V}$ , $I_D = 600\mu\text{A}$ )	$V_{GS(th)}$	—	2	—	V
Gate Quiescent Voltage ( $V_{DD} = 28\text{V}$ , $I_D = 180\text{mA}$ , Measured in Functional Test)	$V_{GS(Q)}$	—	2.7	—	V

**Load Mismatch (In Innogrations Test Fixture, 50 ohm system):**  $V_{DD} = 28\text{Vdc}$ ,  $I_{DQ} = 180\text{mA}$ ,  $f = 2200\text{MHz}$

VSWR 10:1 at 40W pulse CW Output Power	No Device Degradation
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**Figure 1: Pin Connection definition**

Transparent top view (Backside grounding for source)



Pin No.	Symbol	Description
8,9,10,11	RF IN/Vgs1	RF Input, Vgs bias for main path
14,15,16,17	RF IN/Vgs2	RF Input, Vgs bias for peak path
32,33,34,35	RF OUT/VDD1	RF Output, VDD bias for Main path
26,27,28,29	RF OUT/VDD2	RF Output, VDD bias for Peak path
Rest pins	NC	No connection
2,5,7,12,13,18,20,23,25,30,31,36, Package Base	GND	DC/RF Ground. Must be soldered directly to heatsink or copper coin for CW application.

### 1805-1880MHz application board

Reference Circuit of Test Fixture Assembly Diagram

20mils RO4350B

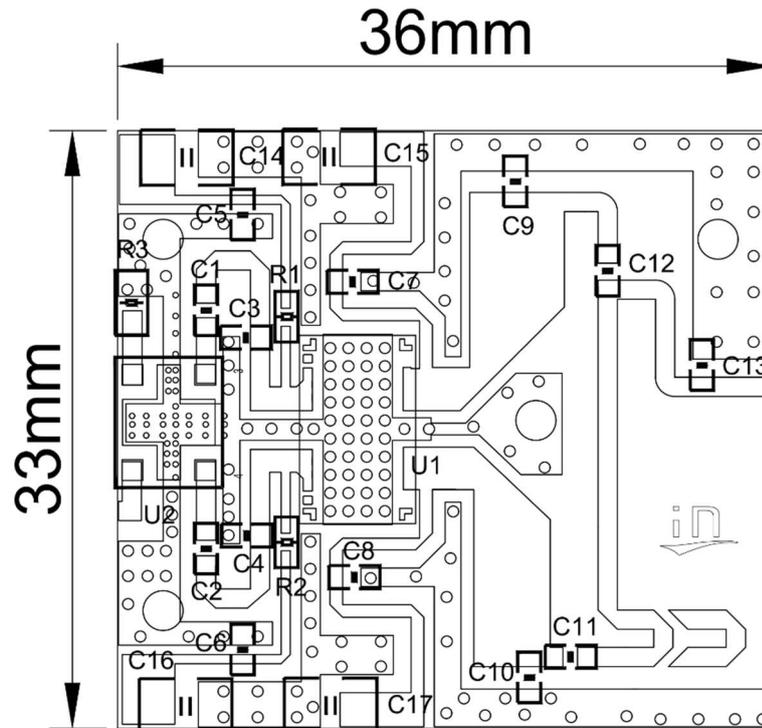


Figure 2. Test Circuit Component Layout

Table 5. Test Circuit Component Designations and Values

Reference	Footprint	Value	Quantity
C1, C2, C5, C6, C7, C8, C11	0603	15pF/250V	7
C3, C4	0603	3.6pF/250V	2
C9	0603	0.3pF/250V	1
C10	0603	0.6pF/250V	1
C12	0603	6.8pF/250V	1
C13	0603	1.2pF/250V	1
C14, C15, C16, C17	1210	10uF/100V	4
R1, R2	0603	10R	2
R3	0603	50R	1
U2	6.35*5.08MM	HC2100P03H	1
U1	C6	ITEH22041C6	1



### TYPICAL CHARACTERISTICS

Figure 5. Power Gain and Drain Efficiency as function of Power Output at Idq=180mA

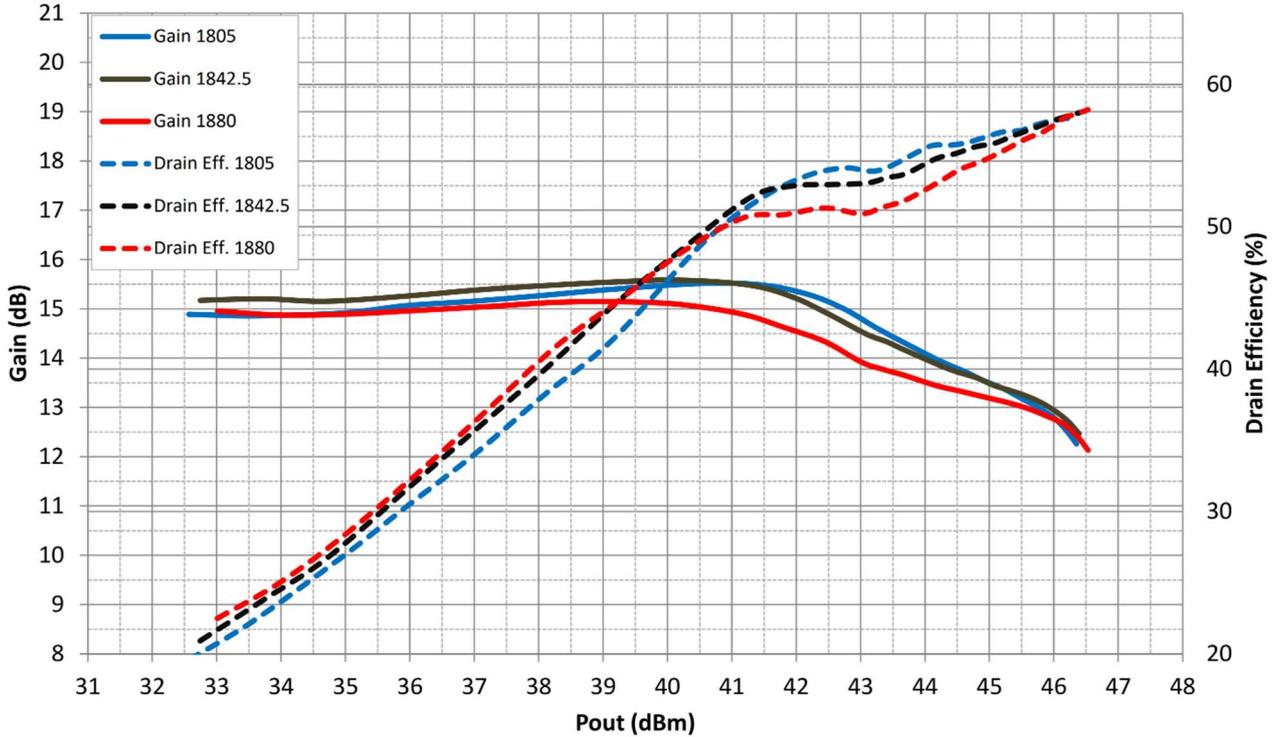
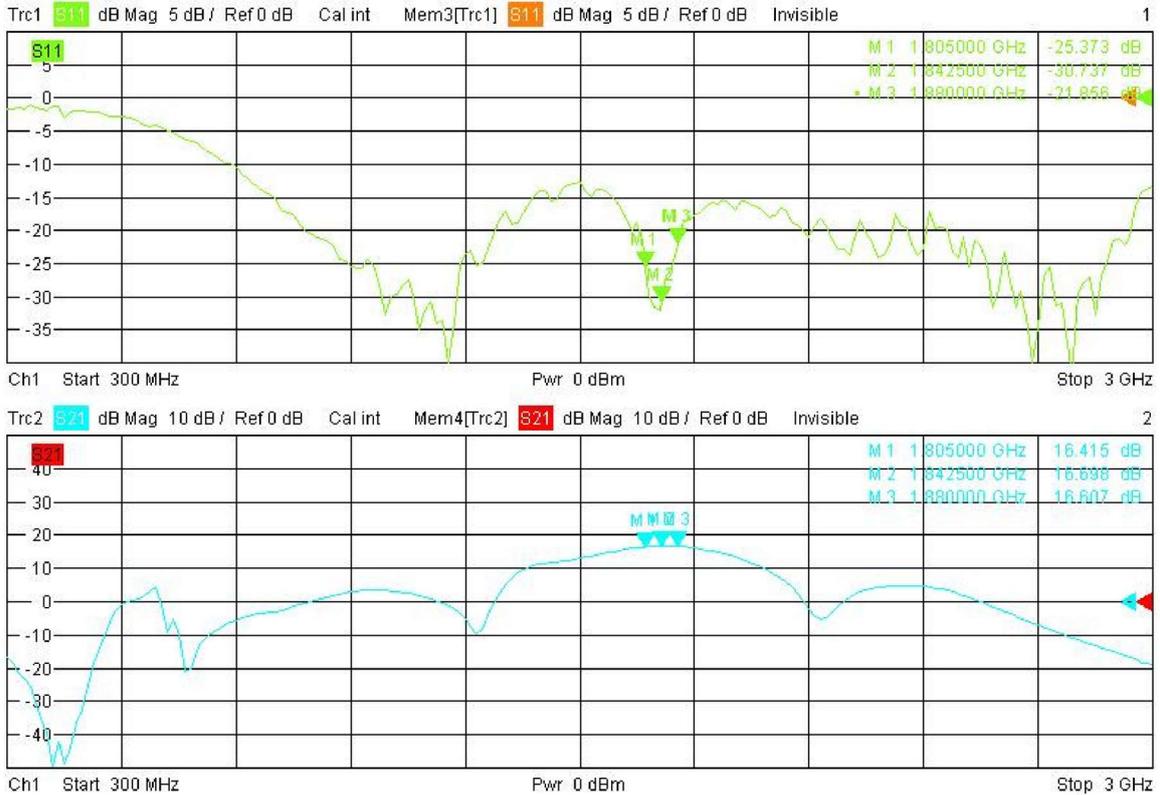


Figure 5. Network analyzer output S11/S21



## 2110-21700MHz application board

Reference Circuit of Test Fixture Assembly Diagram

20mils RO4350B

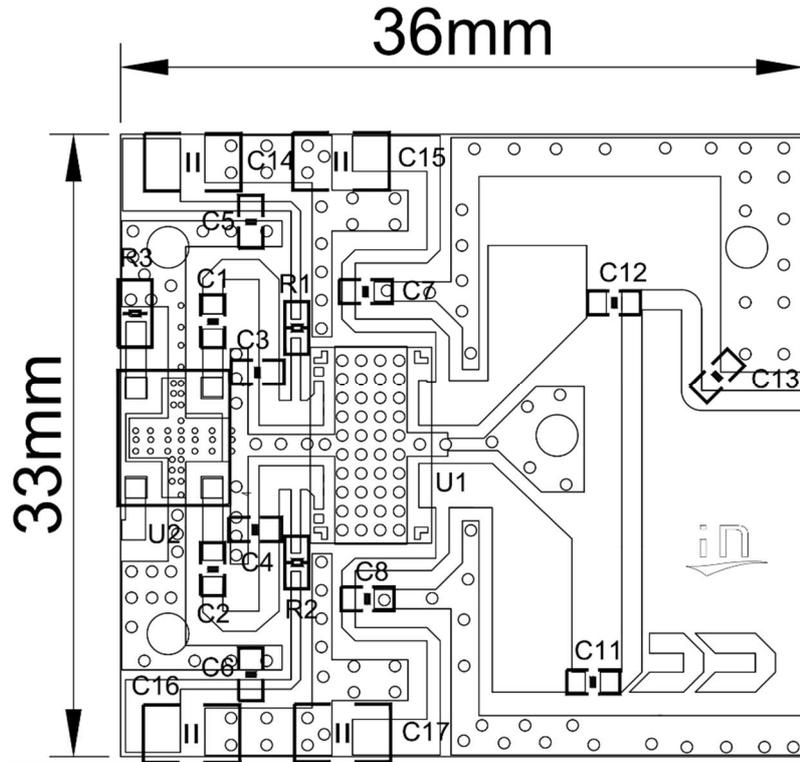


Figure 6. Test Circuit Component Layout

Table 6. Test Circuit Component Designations and Values

Reference	Footprint	Value	Quantity
C1, C2, C5, C6, C7, C8	0603	20pF/250V	6
C3	0603	2.7pF/250V	1
C4	0603	3.0pF/250V	1
C11	0603	2.0pF/250V	1
C12	0603	3.6pF/250V	1
C13	0603	1.1pF/250V	1
C14, C15, C16, C17	1210	10uF/100V	4
R1, R2	0603	10R	2
R3	0603	50R	1
U2	6.35*5.08MM	HC2100P03H	1
U1	C6	ITEH22041C6	1



TYPICAL CHARACTERISTICS

Figure 7. Power Gain and Drain Efficiency as function of Power Output at Idq=180mA

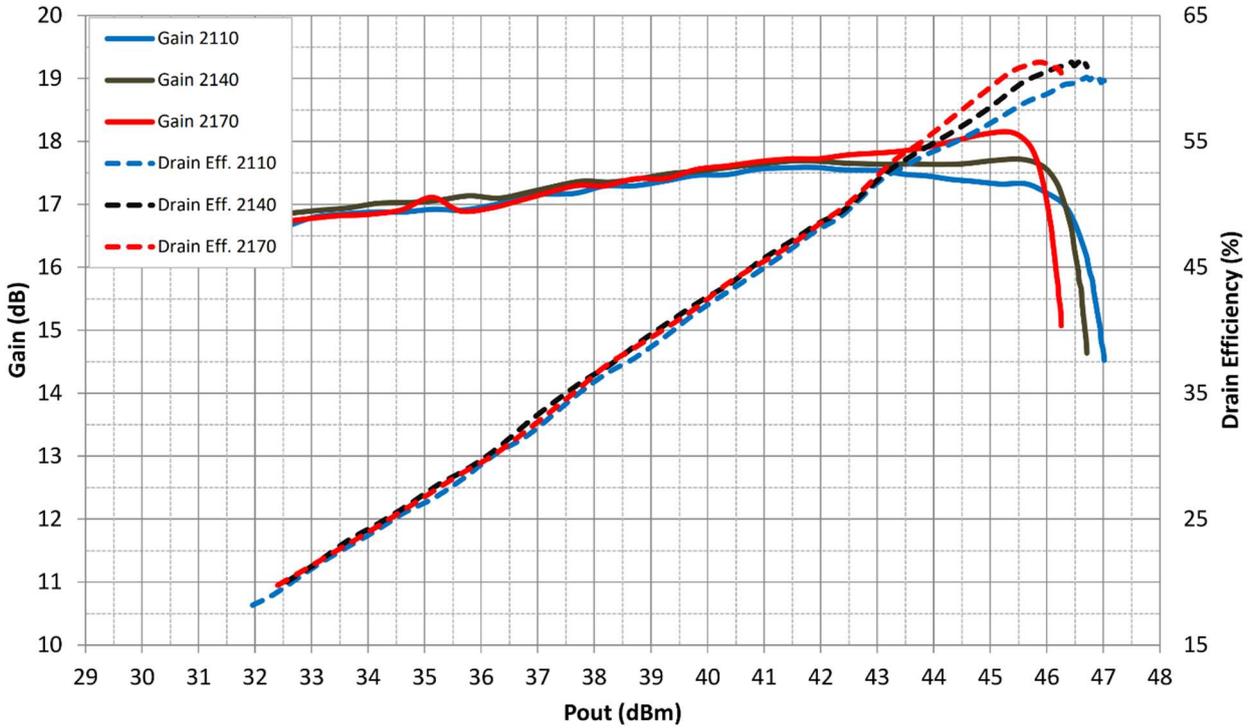
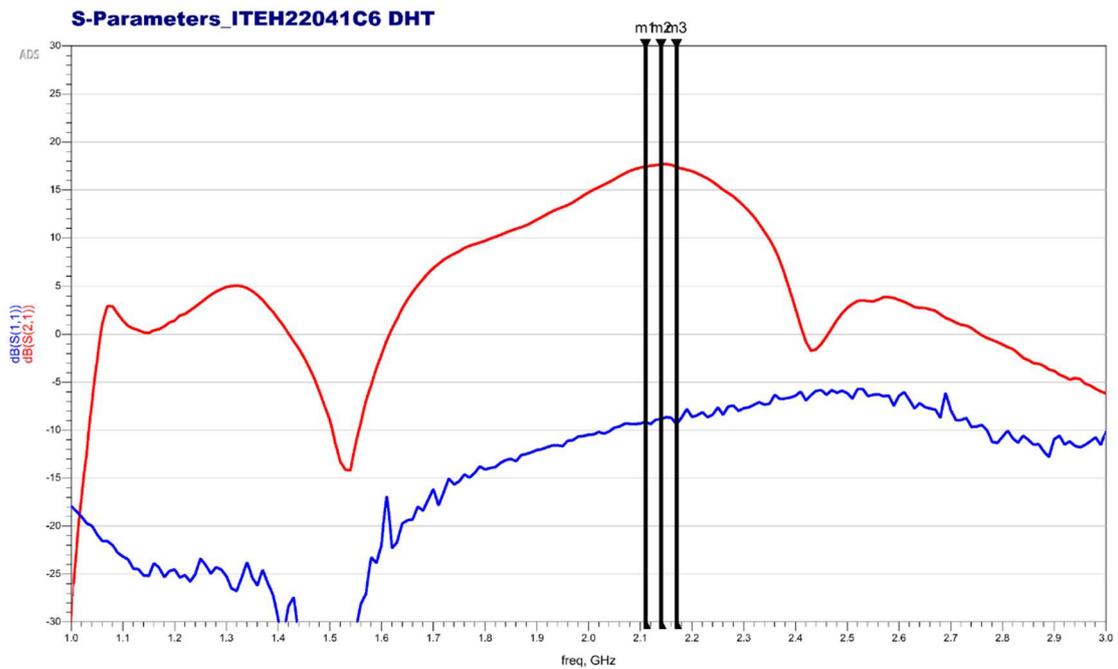


Figure 8. Network analyzer output S11/S21

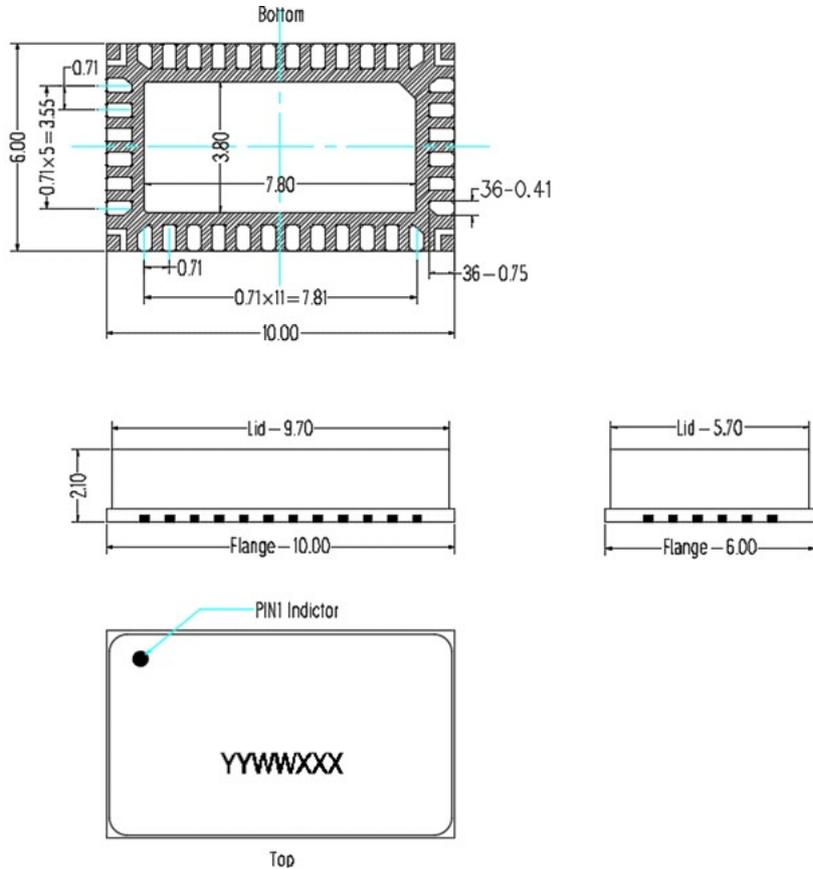
m1 freq=2.110 GHz dB(S(2,1))=17.415 dB(S(1,1))=-9.137	m2 freq=2.140 GHz dB(S(2,1))=17.648 dB(S(1,1))=-8.863	m3 freq=2.170 GHz dB(S(2,1))=17.392 dB(S(1,1))=-9.382
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### Package Dimensions

#### 10\*6 Plastic Package



Notes:

- 1. All dimensions are in mm;
- 2. The tolerances unless specified are ±0.2mm.

### Revision history

Table 7. Document revision history

Date	Revision	Datasheet Status
2023/9/18	Rev 1.0	Preliminary Datasheet

Application data based on ZBB-23-27/28

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